IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for half bridge resonant applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Losses in IH Cooker Application
- $T_{Jmax} = 175^{\circ}C$
- Soft, Fast Free Wheeling Diode
- This is a Pb–Free Device

Typical Applications

- Inductive Heating
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	650	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	80 40	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	160	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	l _F	80 40	A
Diode pulsed current, $\rm T_{pulse}$ limited by $\rm T_{Jmax}$	I _{FM}	160	A
Gate-emitter voltage Transient Gate Emitter Voltage ($t_p = 5 \ \mu s, D < 0.010$)	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	300 150	W
Operating junction temperature range	TJ	–55 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

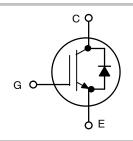
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

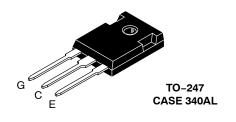


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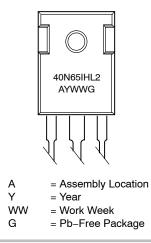
www.onsemi.com

40 A, 650 V V_{CEsat} = 1.8 V E_{off} = 0.36 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N65IHL2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

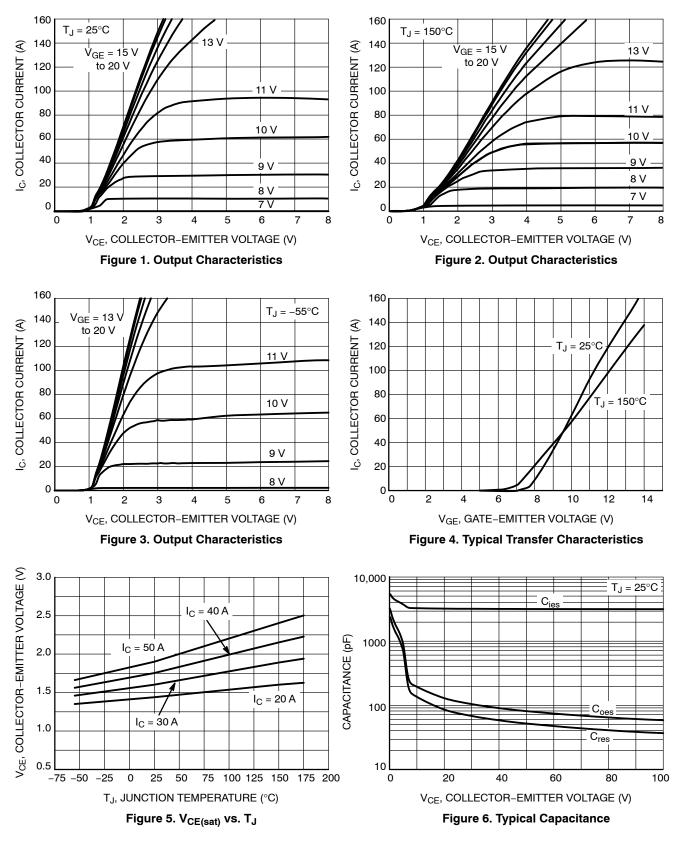
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.50	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.46	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

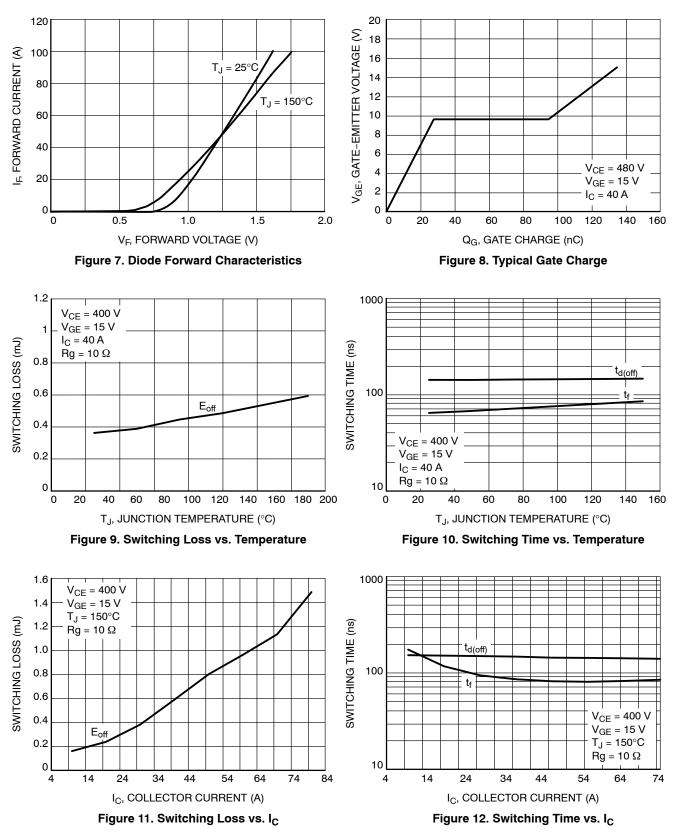
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

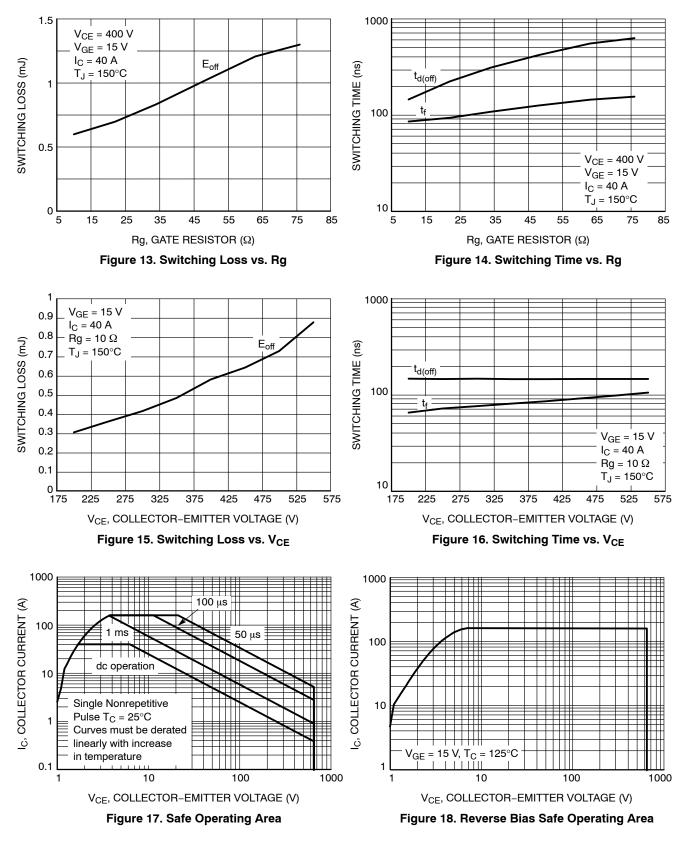
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	650	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}	-	1.8 2.3	2.2 _	V
Gate-emitter threshold voltage	V _{GE} = V _{CE} , I _C = 150 μA	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 650 V V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175°C	I _{CES}	-		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC				•		
Input capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{ies}	-	3200	-	pF
Output capacitance		C _{oes}	-	130	-	
Reverse transfer capacitance		C _{res}	_	85	-	
Gate charge total		Qg	_	135	-	nC
Gate to emitter charge	V _{CE} = 480 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	_	27	-	
Gate to collector charge		Q _{gc}	_	67	-	
SWITCHING CHARACTERISTIC, INDUCT						-
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	140	-	ns
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	65	-	
Turn-off switching loss	$V_{GE} = 0 V/15 V$	E _{off}	-	0.36	-	mJ
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	150	-	ns
Fall time	V _{CC} = 400 V, I _C = 40 A R _g = 10 Ω V _{GE} = 0 V/ 15 V	t _f	-	85	-	
Turn-off switching loss		E _{off}	_	0.60	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 40 A V_{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F	-	1.2 1.16	1.4 _	V
Reverse recovery time	T.₁ = 25°C	t _{rr}	-	465	-	ns
Reverse recovery charge	$I_J = 25^{\circ}C$ $I_F = 40 \text{ A}, V_R = 200 \text{ V}$ $di_F/dt = 200 \text{ A}/\mu\text{s}$	Q _{rr}	_	8700	-	nc
Reverse recovery current		l _{rrm}	_	36	_	А

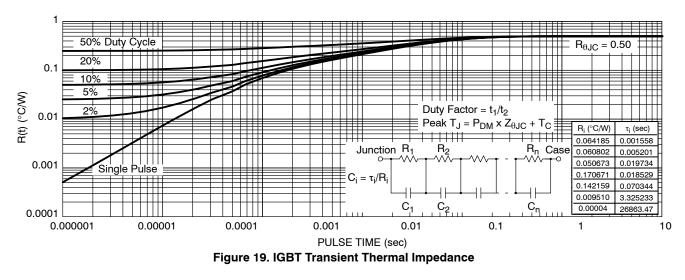
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

I_{rrm}









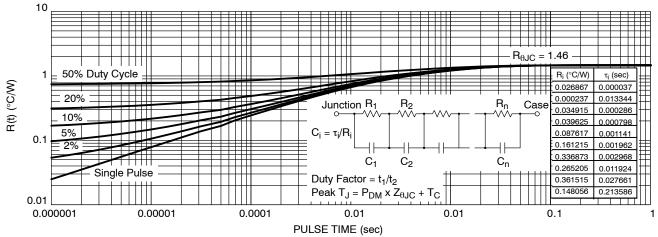


Figure 20. Diode Transient Thermal Impedance

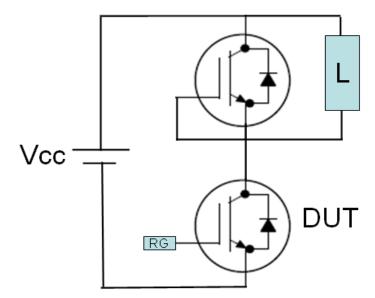
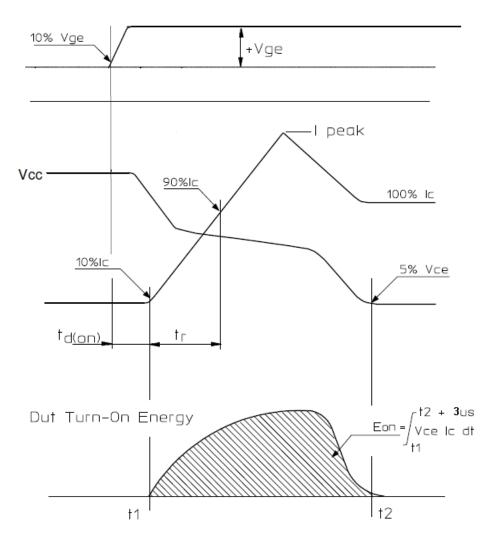
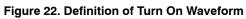


Figure 21. Test Circuit for Switching Characteristics





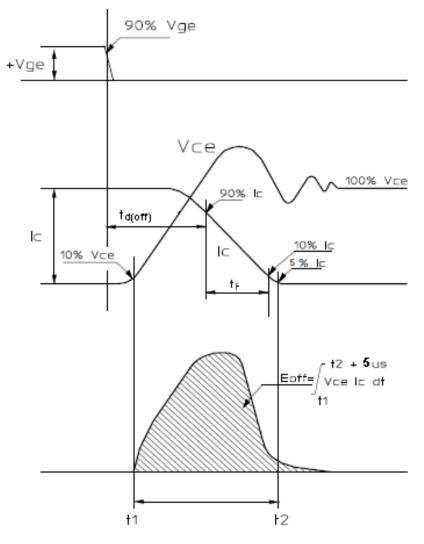
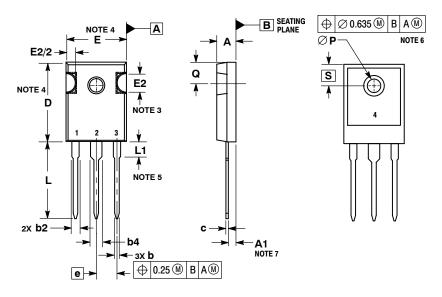


Figure 23. Definition of Turn Off Waveform

PACKAGE DIMENSIONS

TO-247 CASE 340AL **ISSUE A**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
- SLOT REQUIRED, NOTCH MAY BE ROUNDED. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. 4. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY 5.
- ØP SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91. 6
- DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.70	5.30	
A1	2.20	2.60	
b	1.00	1.40	
b2	1.65	2.35	
b4	2.60	3.40	
C	0.40	0.80	
D	20.30	21.40	
E	15.50	16.25	
E2	4.32	5.49	
e	5.45	BSC	
L	19.80	20.80	
L1	3.50	4.50	
Р	3.55	3.65	
Ø	5.40	6.20	
s	6.15 BSC		

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